

Unidirectional ESD protection for transient voltage suppression

Rev. 01 — 9 February 2009

Product data sheet

1. Product profile

1.1 General description

Unidirectional ElectroStatic Discharge (ESD) protection diodes in a very small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and transient overvoltage.

Table 1. Product overview

| Type number | Package | | Configuration |
|-------------|---------|-------|---------------|
| | NXP | JEITA | |
| PESD5V0S1UA | SOD323 | SC-76 | single |
| PESD12VS1UA | | | |

1.2 Features

- Transient Voltage Suppression (TVS) protection of one line
- Max. peak pulse power: P_{PP} = 890 W
- Low clamping voltage: V_{CL} = 19 V
- Low leakage current: I_{RM} = 300 nA
- ESD protection up to 30 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5 (surge); I_{PP} = 47 A
- AEC-Q101 qualified

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems
- Portable electronics
- Medical and industrial equipment

1.4 Quick reference data

Table 2. Quick reference data

 $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------|--------------------------|------------------------|-----|-----|-----|------|
| V_{RWM} | reverse standoff voltage | | | | | |
| | PESD5V0S1UA | | - | - | 5 | V |
| | PESD12VS1UA | | - | - | 12 | V |
| C_d | diode capacitance | $f = 1 MHz; V_R = 0 V$ | | | | |
| | PESD5V0S1UA | | - | 480 | 530 | pF |
| | PESD12VS1UA | | - | 160 | 180 | pF |



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2. Pinning information

| Tab | le 3. | Pinniı | 10 |
|------------|-------|--------|----|
| | | | |

| Pin | Description | Simplified outline | Graphic symbol |
|-----|-------------|--------------------|----------------|
| 1 | cathode | [1] | |
| 2 | anode | 1 2 | 1 2 2 2 |

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 4. Ordering information

| Type number | Package | | |
|-------------|---------|------------------------------------------|---------|
| | Name | Description | Version |
| PESD5V0S1UA | SC-76 | plastic surface-mounted package; 2 leads | SOD323 |
| PESD12VS1UA | | | |

4. Marking

Table 5. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PESD5V0S1UA | AV |
| PESD12VS1UA | AW |

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------|--------------------|----------------------|--------|------|------|
| P_{PP} | peak pulse power | $t_p = 8/20 \ \mu s$ | [1][2] | | |
| | PESD5V0S1UA | | - | 890 | W |
| | PESD12VS1UA | | - | 600 | W |
| I_{PP} | peak pulse current | $t_p = 8/20 \ \mu s$ | [1][2] | | |
| | PESD5V0S1UA | | - | 47 | Α |
| | PESD12VS1UA | | - | 22.5 | Α |

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Table 6. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|-----------------------------|--------------|------|------|
| P _{tot} | total power dissipation | $T_{amb} \le 25 ^{\circ}C$ | [3] _ | 360 | mW |
| | | | <u>[4]</u> _ | 500 | mW |
| Tj | junction temperature | | - | 150 | °C |
| T_{amb} | ambient temperature | | –55 | +150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |

- [1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.
- [2] Soldering point of cathode tab.
- [3] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

Table 7. ESD maximum ratings

T_{amb} = 25 °C unless otherwise specified.

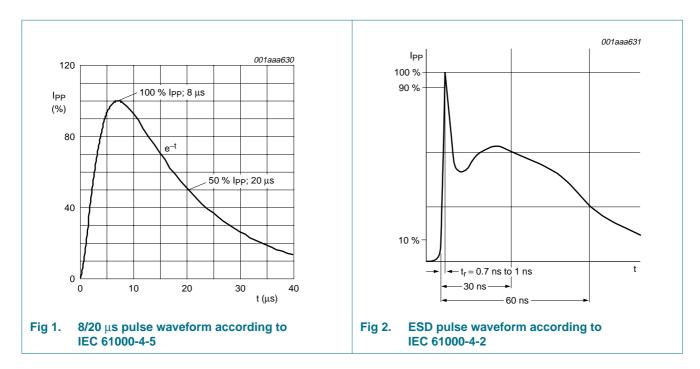
| Symbol | Parameter | Conditions | | Min | Max | Unit |
|-----------|---------------------------------|--------------------------------------|------------|-----|-----|------|
| V_{ESD} | electrostatic discharge voltage | IEC 61000-4-2 (contact discharge) | <u>[1]</u> | - | 30 | kV |
| | machine model | | - | 400 | V | |
| | | MIL-STD-883 (human body model) | | - | 16 | kV |

^[1] Device stressed with ten non-repetitive ESD pulses.

Table 8. ESD standards compliance

| Standard | Conditions |
|-----------------------------------------|---------------------------------|
| IEC 61000-4-2; level 4 (ESD) | > 15 kV (air); > 8 kV (contact) |
| MIL-STD-883; class 3 (human body model) | > 4 kV |

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6. Thermal characteristics

Table 9. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--------------------------------------------------|-------------|-------|-----|-----|------|
| R _{th(j-a)} | thermal resistance from | in free air | [1] - | - | 345 | K/W |
| | junction to ambient | | [2] _ | - | 250 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | [3] _ | - | 90 | K/W |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [3] Soldering point of cathode tab.

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7. Characteristics

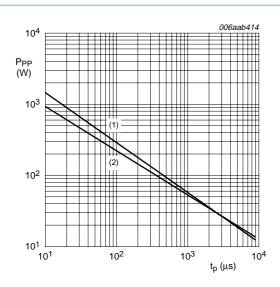
Table 10. Characteristics

T_{amb} = 25 °C unless otherwise specified.

| Symbol | Parameter | Conditions | M | in Ty | р Мах | Unit |
|------------------|--------------------------|---------------------------|-----|--------|---------|------|
| V_{RWM} | reverse standoff voltage | | | | | |
| | PESD5V0S1UA | | - | - | 5 | V |
| | PESD12VS1UA | | - | - | 12 | V |
| I _{RM} | reverse leakage current | | | | | |
| | PESD5V0S1UA | $V_{RWM} = 5 V$ | - | 0.3 | 3 4 | μΑ |
| | PESD12VS1UA | $V_{RWM} = 12 V$ | - | < 1 | 100 | nA |
| V_{BR} | breakdown voltage | $I_R = 5 \text{ mA}$ | | | | |
| | PESD5V0S1UA | | 6. | 2 6.8 | 7.3 | V |
| | PESD12VS1UA | | 13 | 3.3 14 | .5 15.7 | 5 V |
| C _d | diode capacitance | f = 1 MHz; $V_R = 0 V$ | | | | |
| | PESD5V0S1UA | | - | 48 | 0 530 | pF |
| | PESD12VS1UA | | - | 16 | 0 180 | pF |
| V _{CL} | clamping voltage | | [1] | | | |
| | PESD5V0S1UA | $I_{PP} = 47 \text{ A}$ | - | - | 19 | V |
| | | $I_{PP} = 25 \text{ A}$ | - | - | 13.5 | V |
| | | $I_{PP} = 5 A$ | - | - | 9.8 | V |
| | PESD12VS1UA | $I_{PP} = 22.5 \text{ A}$ | - | - | 27 | V |
| | | I _{PP} = 15 A | - | - | 23.5 | V |
| | | $I_{PP} = 5 A$ | - | - | 19 | V |
| r _{dif} | differential resistance | $I_R = 5 \text{ mA}$ | | | | |
| | PESD5V0S1UA | | - | 2 | 100 | Ω |
| | PESD12VS1UA | | - | 5 | 100 | Ω |

^[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

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 $T_{amb} = 25 \, ^{\circ}C$

- (1) PESD5V0S1UA
- (2) PESD12VS1UA

Fig 3. Peak pulse power as a function of exponential pulse duration; typical values

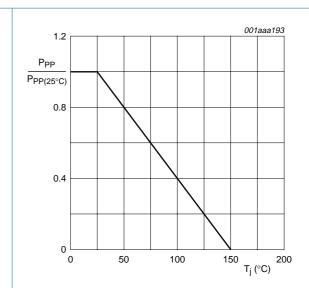
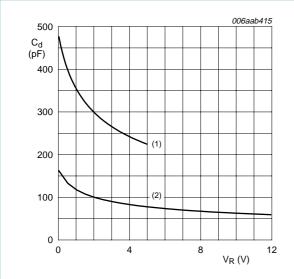


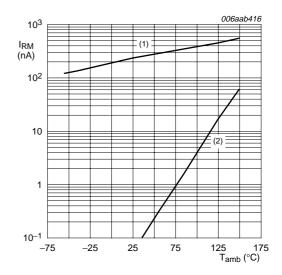
Fig 4. Relative variation of peak pulse power as a function of junction temperature; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$

- (1) PESD5V0S1UA
- (2) PESD12VS1UA

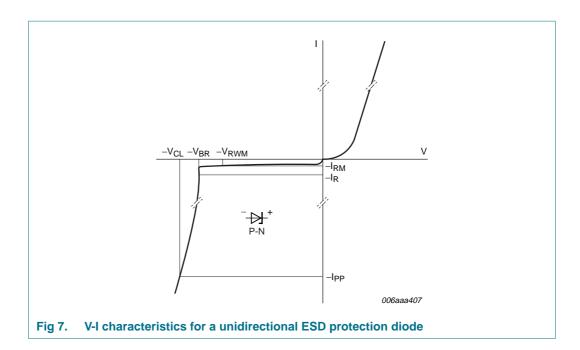
Fig 5. Diode capacitance as a function of reverse voltage; typical values



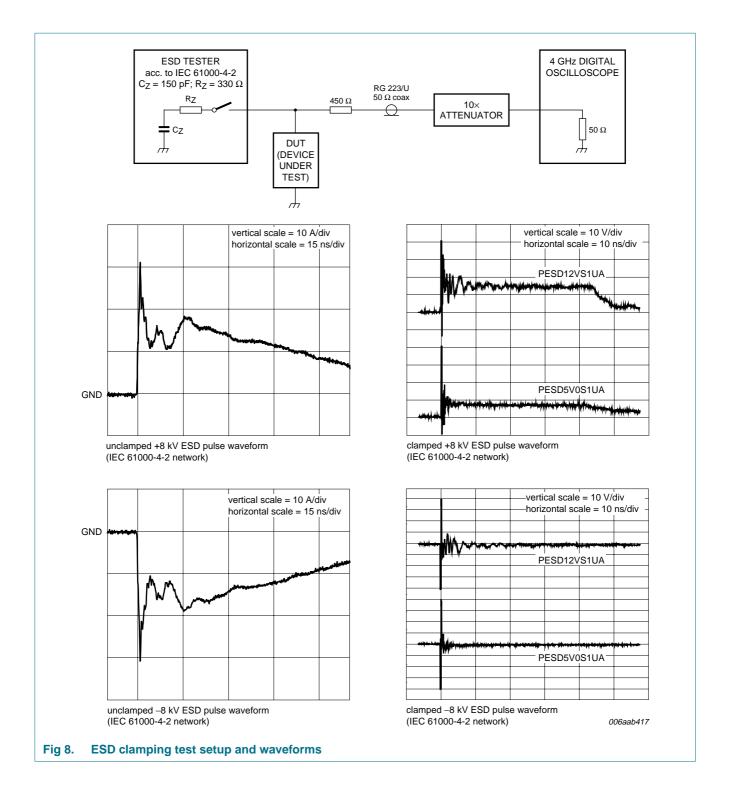
- (1) PESD5V0S1UA
- (2) PESD12VS1UA

Fig 6. Reverse leakage current as a function of ambient temperature; typical values

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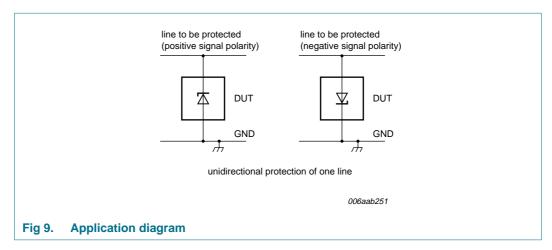


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8. Application information

PESD5V0S1UA and PESD12VS1UA are designed for the protection of one unidirectional data or signal line from the damage caused by ESD and transient overvoltage. The devices may be used on lines where the signal polarities are either positive or negative with respect to ground.

The PESD5V0S1UA provides a surge capability of 890 W and the PESD12VS1UA provides a surge capability of 600 W per line for an 8/20 µs waveform.



Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD and Electrical Fast Transient (EFT). The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. The path length between the device and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

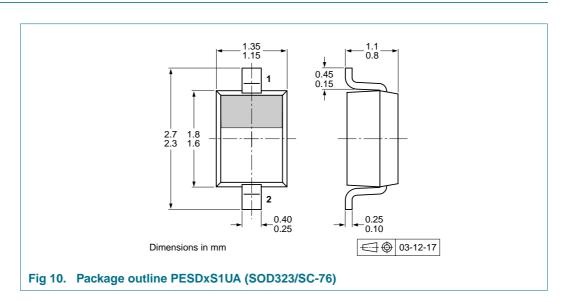
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9. Test information

9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

10. Package outline



11. Packing information

Table 11. Packing methods

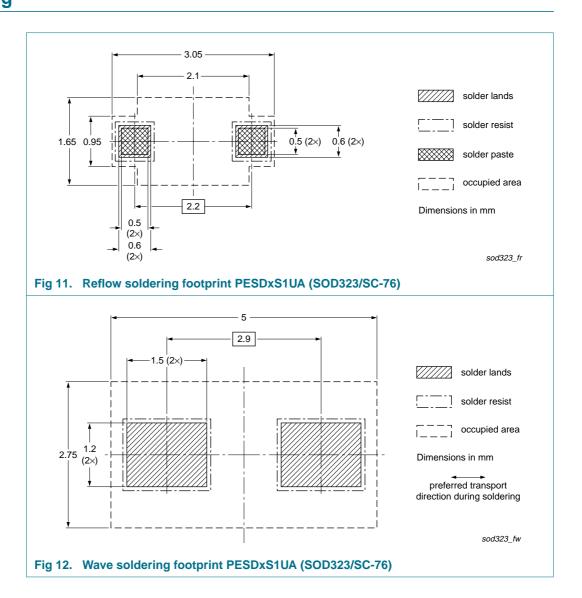
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description | Packing | Packing quantity | |
|-------------|---------|--------------------------------|---------|------------------|--|
| | | | 3000 | 10000 | |
| PESD5V0S1UA | SOD323 | 4 mm pitch, 8 mm tape and reel | -115 | -135 | |
| PESD12VS1UA | | | | | |

[1] For further information and the availability of packing methods, see Section 15.

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12. Soldering



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13. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---------------------------|--------------|--------------------|---------------|------------|
| PESD5V0S1UA_PESD12VS1UA_1 | 20090209 | Product data sheet | - | - |

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14. Legal information

14.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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- [2] The term 'short data sheet' is explained in section "Definitions"
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PESD5V0S1UA; PESD12VS1UA

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